Multi-Gigabit Wireless Data Transfer for High Energy Physics Applications

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The future of connectivity is wireless and in that context the High Energy Physics (HEP) community is no exception. The volume of data produced at the Large Hadron Collider (LHC) is immense and represents a considerable processing challenge. Moreover the LHC and future hadronic colliders are the most demanding environments, with respect to ultra-low latencies, ultra-high data rate, reliable indoor coverage and harsh radiation environment in the world. Any technology meeting the above conditions will have to satisfy the standard requirements of energy efficiency, low cost and security. Today, the data transmission in HEP experiments is based on wire and optical readout architecture. We propose the use of wireless data transmission described here as a third option. This paper presents the motivation and overviews of the status of our ASIC development and first ideas for wireless readout and control. In this first phase of development, we will focus on the 60 GHz band, which provides high bandwidth, small form factor and is a mature technology. Open issues and future strategy are also briefly discussed.
1. Introduction

The 4th industrial revolution is on the way, and in front of us is a new era of wireless data traffic/transfer approaching fast. Wireless communication is actually the fastest growing part in the communication industry at time and is actually all around us. The driver behind this revolution is the rapid transistor technology evolution, which triggered the opening of the mm-wave band, that in turn opens the doors for Internet of Things (IoT), smart homes, 5G, autonomous automotive industry, cloud computing and a myriade of opportunities in healthcare, etc. In all these aspects there is pressure towards higher and higher bandwidth, where “Edholms law” predicts that wireless data volumes would double every 18 months. It is anticipated that the development of these cutting-edge devices will totally change the way we live, work and interconnect with each other. This trend towards a wireless future will surely affect and drive the developments for future instrumentation in the HEP community.

The WADAPT\textsuperscript{1} consortium proposes wireless data transmission as an alternative to wire and optical readout architecture presently in use in HEP experiments. It is well known that, with almost all the available spectrum below 6 GHz being allocated, it is mandatory to move to higher frequency bands to secure bandwidth. However, as the frequency increases, RF propagation and penetration through materials etc. are reduced, which will prevent wireless data leaking from one sector to adjacent sectors. Thus, the bandwidths available above 6 GHz lend themselves to short-range, point-to-point, Line-Of-Sight (LOS) connections. The band that has attracted the highest interest in this context is the mm-wave band. The mm-wave band is defined where the wavelength varies from ten millimeters (30 GHz) down to 1 millimeter (300 GHz). In the first phase the WADAPT consortium \cite{1} will concentrate on data transfer communication in the 60 GHz band (57 GHz - 66 GHz), where the 9 GHz license free band is extremely attractive in order to achieve a high data rate transfer.

The major reasons for using wireless communication in a HEP like environment is due to all the advantages it brings in terms of cable (material) reduction, small form factor, high material penetration loss, high free path loss, narrow beamwidth, flexible deployment, easy maintenance, fiber comparable data rate transfer, ultra-low latency, high quality, reliability, security and implementation of new applications such as wireless control. All in all this will reduce the overall cost of the present detector readout system. In addition, the wireless communication technology is not constrained to mechanical structures, like for example optical links and wires that has to follow the structure of the given construction. All these features, added to the operation in a very well controlled environment with LOS operation, make the 60 GHz band optimal for short range operation as in a closed detector environment.

The planning and construction of the existing detectors were done in the “Pre-Wireless age”, and the future need of extreme data rates in the order of 10 Gb/s and beyond in a compact and densely populated detector facility. Therefore, to fully exploit the advantages of integrating a fully wireless point-to-point readout, a re-thinking of the detector topology is mandatory. This means the coverage, the capacity demand and the topology for the specific detector. Understanding these aspects from the wireless point of view, will help constructing an optimum distribution strategy for all of the HEP requirements.

\textsuperscript{1}Wireless Allowing Data and Power Transmission
Wireless communication also leads to a more efficient system control management. A wireless control solution provides reliable, flexible and secure operation that will allow a greater control while reducing total implementation and maintenance cost. Higher performances and more reliable communications with respect to current technologies are expected from these characteristics.

Wireless data transmission could help to reduce the number of cables (optical or copper) used for data transmission as well as their connectors, which are prone to damage. With less cables and connectors, installation and repair of such a complex system like a tracking detector can be simplified. Moreover, cables contribute significantly to the material budget in the active detector volume, which leads to multiple scattering and acts as a source of secondary particles. For example a wireless control solution will make it possible to transfer large amount of data in both directions in real-time with minimum latency to a large number of individual devices; this would be impracticable by using wire or optical connections, which are bound to follow the mechanical architecture. This could be used to enhance on-detector intelligence such as on-line finding of tracks with high transverse momentum for a fast trigger as the data could be read along particle trajectories. To increase the efficiency of the detector an instantaneous optimization based on real-time monitoring of the performance of the sub-components is also possible. This could be interesting for detector synchronization or for the distribution of a system wide reset or trigger signal. Also increased processing capabilities will be needed to cope with increasing levels of intelligence required to process complex stimuli in real-time. The amount of data, control signal to share/use and to make on-the-spot decision has a significant potential. For example Figure 1 shows several possible scenarios of new topologies that can be created more easily than using wire or optical links. 

![Figure 1](image_url)

**Figure 1:** Left: Proposal of a radial readout for the tracker detector of the ATLAS experiment [2]. Right: Different readout/control compositions that can be created using a wireless realization. Single Output transmitter, Single Input receiver (SISO), Single Input receiver, Multiple Output transmitter (SIMO), Multiple Input receiver, Single Output transmitter (MISO), Multiple Input receiver, Multiple Output transmitter (MIMO)

Not all of the sensors need to be operated in the mm-wave band, some may communicate at low-bit-rates but with ultra-low latency and ultra-high reliability, and may require reliable high-bandwidth communication. An example could be transfer of a huge amount data for fast intervention, maintenance or assembly tasks, or functions such as remote control of other modules.
In this development many requirements have to be fulfilled at similar or lower cost and energy dissipation as the existing system.

2. Transceiver Design

Several different wireless transceiver topologies and IC technologies exist, which are very specification dependent and will not be discussed in this paper. The first prototype of the Heidelberg transceiver chip as shown in Figure 2 [3, 4] is designed to handle a data rate of 4.5 Gbps over a link distance of about 1m.

With the present design a total estimated power consumption for the first prototype is about 150 mW. This first prototype design will be taped-out in IBM SiGe BiCMOS 130 nm 8HP technology. In the 60 GHz band a bandwidth of 9 GHz is available. This allows for high data rates and low complexity modulation schemes.

<table>
<thead>
<tr>
<th>Specifications</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Frequency band</td>
<td>57.66 GHz</td>
</tr>
<tr>
<td>Bandwidth</td>
<td>9 GHz</td>
</tr>
<tr>
<td>Data Rate</td>
<td>4.5 Gbps</td>
</tr>
<tr>
<td>Modulation</td>
<td>OOK</td>
</tr>
<tr>
<td>Minimum sensitivity $S_{\text{MIN}}$</td>
<td>-49 dBm</td>
</tr>
<tr>
<td>Bit Error Rate (BER)</td>
<td>10$^{-5}$</td>
</tr>
<tr>
<td>Target Power consumption</td>
<td>150 mW</td>
</tr>
<tr>
<td>Transmission Range</td>
<td>20 cm (1m)</td>
</tr>
</tbody>
</table>

Figure 2: Block diagram of the Transceiver. The transmitter is shown at the top and the receiver at the bottom.

Figure 3: Summary of the specifications used for the ASIC design.

The power consumption is heavily dependent on specifications like data rate, transfer distance and antenna gain. There is room for improvements regarding power consumption and the effort will be pursued in that direction. The initiated transceiver chip development is foreseen to grow in complexity and functionality as we explore the possibilities. One ultimate scenario could be
to integrate/readout the exciting ABCn chip of ATLAS with the transceiver chip implemented in same topology to create a System-on-Chip (SoC) or using 3D integration as shown in Figure 7. This offers significant advantages when it comes to further minimizing the mass, volume, power consumption and development cost, while giving the possibility of increased data rate and channel density.

![Figure 4: Left: Block diagram of the transceiver. The transmitter is shown at the top and the receiver at the bottom. Right: Layout of the CEA-Leti Chip](image)

CEA-Leti has co-developed a transceiver with industrial partners as shown in Figure 4. The CEA-Leti 60 GHz chip is able to reach 5 Gbps and 10 Gbps over a short distance (few centimeters) with a BER $<10^{-12}$ and a power consumption of 40 mW in transmission and 20 mW in reception [5]. The range is 0.2 m with single antenna with a scalable data rate from 100 Mbps to 2.5 Gbps. This prototype undergoes now the first irradiation tests to investigate potential issues under operation.

3. Antenna Design

The antenna is a critical component in the transceiver chain. The 60 GHz carrier frequencies and above enable antennae to be placed much closer together than 2.4 GHz or 5 GHz carrier frequencies. Antennae operating at such high frequency are typically very directional. In fact, multiple antennas can be placed on a single chip that can be used for beamforming to increase the received power. Operation in the 60 GHz or mm-wave band also makes it possible the use of massive antenna configurations on-chip, which makes intelligent wireless control feasible.

The work of the Uppsala group [2] encompasses the design and simulation of various antenna types for usage in detector environments, their fabrication and characterization. The first irradiation with electrons of 5 Mev (100 krad dose), 120 Mev (100 krad and 10 Mrad) have been conducted with very positive outcome [6].

4. Feasibility Study

To evaluate the influence and other potential issues that could appear under operation of the 60 GHz RF signal on electronics and material used for the ATLAS tracker readout in this case,
60 GHz Evaluation Kit from Hittite was installed and the following measurements were completed in Heidelberg\footnote{Physikalisches Institut, University of Heidelberg}: data transmission, material properties, antenna characterization, cross-talk, link density and noise pick-up. A very important aspect is to understand how the circuit behaves and influences other circuits in the vicinity of the transceiver. No influence on transceiver chips working in the 60 GHz band from other chips in the vicinity are expected. The many metallic surfaces could lead to strong multipath components of the radio signal that may cause fading. Tests with an ITK hybrid with ABCn 130 nm readout ASICs showed no observable effect on the module’s noise performance. A detailed description of the above tests can be found in [7].

5. Future Strategy and open issues

There are many possibilities but also some open issues. Since this wireless readout development is planned for the next generation of detector systems, a major focus in this development is naturally on the power consumption, space, reliability, and for some sub-systems it has to be extremely radiation hard. For example the wireless transceiver ASIC will be exposed to about
10 times higher radiation dose than the current LHC ASICs in the worst case. Thus a deep understanding of the final system application and applied IC technology is mandatory. Significant technological evolution can also be expected in the coming years. What technology to use and where to use it in the detector depends on many factors. For example for which application is IC radiation hard technology needed, what are the bandwidth requirements for the different modules, where is analog performance and feature size relevant, where is power consumption important.

There are applications in the detector environment that could potentially gain from the ultra-low latency. With the possibility of ultra-low latency applications, a latency budget analysis of the current/future data transmission path will be a first step towards reduced latency and finding new applications. The main question is where this ultra-low latency offers new opportunities in the form of applications or services. For this, the focuses have to be super real-time and reliable connections, new applications and cases where very strict requirements on latency and reliability are needed. Moreover, the way to wirelessly handle/control a large number of devices, and to handle a large number of links in an extremely dense environment as a detector environment has to be defined.

The next big challenge is to evaluate the benefit for the HEP community, which could result from a fully or partial designed wireless power distribution in/off detector when it comes to the enormous potential of cable reduction.

Since the future detectors will be highly granular, and maybe un-triggered, a large amount of data has to be readout in short time, and will require high bandwidth and compact design to read out the data in Terabits per second. An attractive solution is therefore to integrate the wireless transmitter onto the already existing readout chip, for example the VIPRAM chip [8] or the existing ABCn chip for ATLAS, which then will be the first chip of this kind in the world. With this solution, a further improvement in form factor, power consumption, functionality etc. is foreseen.

6. Summary

This paper describes the first steps of the WADAPT consortium in this innovative development with potentially huge outreach, by providing a practical alternative to wire and optical links.
to readout large amount of data. Each of the three options has pros and cons and is extremely application dependent. A close collaboration with the HEP community to evaluate these three options for optimum usage is needed.

As already mentioned above the environment of the LHC and future colliders is one of the most demanding in the world for wireless data processing, with respect to ultra-low latencies, cross-talk, ultra high data rate, reliable indoor coverage, harsh radiation environment etc., on top of the standard detector requirements of energy efficiency and low cost. The wireless solution has many advantages compared to existing readout systems. Among them are cable/material reduction, small form factor, controllable beamwidth and data transfer intensity (length). In addition high path loss, high penetration loss leads to the absence of cross-talk between adjacent modules and make the frequency reuse possible. The flexible deployment, easy maintenance, ultra-low latency, fiber like data rate transfer, high quality, high reliability, security, the absence of constrain to mechanical structures, contrarily to wire and optical links, make it easier the implementation of new applications like wireless control. Moreover wireless data processing is an extremely challenging opportunity with unprecedented potential for commercial exploitation.

New readout topologies are possible which have the potential of providing a more efficient system control that can minimize downtime, and provide feedback control to enhance system quality. It is well known that the optical link connection has the highest peak data transfer rate possible today due to its enormous bandwidth. Wireless is free of wires going everywhere, it can communicate to multiple devices where wire or optical link is costly or infeasible to install. The optimum solution is highly case dependent. The mmWave band offers the possibility of a new generation of readout with very low latencies and massive bandwidth. The wireless readout needs to match the existing network in terms of delivered quality, reliability and security. To do so, we need in the long term to deliver fiber like 10 Gb/s speed.

The future of connectivity is wireless and the HEP community will surely draw great benefit from this developing technology. The success of this project can in addition enhance the global competitiveness and the cutting edge wireless technology.

References


